



Product Change Notification

Change Notification #: 116063 - 00
Change Title: Intel® Compute Card CD1C64GK,
 Intel® Compute Card CD1P64GK,
 PCN 116063-00, Product Material,
 Documentation,
 Power Delivery Controller and Booklet
 Update
Date of Publication: February 07, 2018

Key Characteristics of the Change:

Product Material, Documentation

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 5, 2018
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Description of Change to the Customer:

The Intel® Compute Card SKUs listed in the products affected table below will have the following changes.

1. For BLKCD1C64GK the Realtek PDIC (Power Distribution Integrated Circuit) RTS5440 is being replaced with RTC5450 to match what is already in use in BLKCD1P64GK.
2. The Booklet is being updated to include new BSMI inspection requirements for both SKUs.

Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

For your information only. No change to form fit or function of the product. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Pre Change AA	Post Change TA	Post Change SA	Post Change AA
BLKCD1C64GK	956383	J60265-103	J51412-502	J48965 - 502	J60265-104	J51412-503	J48965-503
BLKCD1P64GK	956387	J60256-103	J51411-502	J48967 - 502	J60256-104	NA	NA

PCN Revision History:

Date of Revision: February 7, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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